

TFT-LCD PRODUCT SPECIFICATION

PART NUMBER:	USMP-VC070WV-03L-TP		
DESCRIPTION:	7.0"TFT LCD with 800 x 480 resolution, 6-bit LVDS interface, 12 V VLED driver and capacitive touch panel with USB interface		

ISSUE DATE	APPROVED BY	CHECKED BY	PREPARED BY	
	(Customer Use Only)			
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Revision Date	Page	Contents	Editor
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1. INTRODUCTION

This US Micro Products module is a color active matrix TFT-LCD that uses amorphous silicon TFT as a switching device. This model is composed of a TFT-LCD panel, LCD driving circuit, LED back-light and Projective Capacitive touch panel. This TFT-LCD has a high resolution (800(R.G.B) X 480) and can display up to 262,144 colors.

1-1. Features

- 7" WVGA (16:9 diagonal) configuration
- LED Back-light is with CABLE connection
- Interface: 6-bits LVDS interface
- Capacitive Touch Panel with USB Interface.
- LED Driver (VLED = 12V)

1-2. Applications

- Portable TV
- Car user DVD
- Industrial application
- HMI (Human machine interface)

2. PHYSICAL SPECIFICATIONS

Item	Specifications	unit
Display resolution(dot)	800RGB (W) x 480(H)	dots
Active area	152.4 (W) x 91.44 (H)	mm
Pixel pitch	0.1905 (W) x 0.1905 (H)	mm
Color configuration	R.G.B Vertical stripe	
Overall dimension	187.76.0(W) x 132.18(H) x 12.58(T)	mm
Brightness	850	cd/m ²
Contrast ratio	ontrast ratio 300 : 1	
Backlight unit	LED	
Display color	262,144	colors



3. ABSOLUTE MAX. RATINGS

3-1 Electrical Absolute Rating

3-1-1 TFT LCD Module

ltom	Symbol	Val	ues		Noto
nem	Symbol		Max.		NOLE
Power voltage	VCC	-0.5	4.0	V	GND=0V
Voltage range at any terminal		-0.5	VCC+0.3	V	

3-2 Environment Absolute Rating

ltem	Symbol	Min.	Max.	Unit	Note
Operating Temperature	Тора	-20	70	°C	
Storage Temperature	Tstg	-30	80	°C	



4. ELECTRICAL CHARACTERISTICS

4-1 TFT LCD Module voltage

		MIN	NOM	MAX	UNIT
V _{CC}	Supply voltage	3	3.3	3.6	V
$V_{\rm IH}$	High-level input voltage (SHTDN)	2			V
V_{IL}	Low-level input voltage (SHTDN)			0.8	V
$ V_{ID} $	Magnitude differential input voltage	0.1		0.6	V
V _{IC}	Common-mode input voltage	$\frac{ V_{ D} }{2}$		$2.4 - \frac{ V_{ID} }{2}$	V



ITEM	SYMBOL	MIN	TYP	MAX	UNIT	CONDITION
Power Supply Voltage For LCD	Vcc	3.0	3.3	3.6	V	
Power Supply Current For LCD	lcc	-	180	230	mA	Black pattern
Power Supply Voltage For LED	VLED	-	12	14	V	
ADJ signal frequency	fрwм	5		100	kHz	
ADJ signal logic level High	VIH	-	3.3	5.0	V	
ADJ signal logic level Low	VIL	-	-	0.5	V	



4-2 LED Driving Conditions

ITEM	SYMBOL	MIN	TYP	MAX	UNIT	CONDITION
LED Backlight Voltage	V _{BL}	15.0	16.5	18.0	V	For reference
LED Backlight Current	I _{BL}	-	240	-	mA	Ta=25°C
LED Life Time			50K		Hr	Note*

Note* : Brightness to be decreased to 50% of the initial value.





The constant current source is needed for white LED back-light driving.

When LCM is operated over 60 $^\circ\!{\rm C}$ ambient temperature, the I_{BL} of the LED back-light should be adjusted to 200mA max



4-3 Touch Panel Basic Characteristic

ITEM	SPECIFICATION
Туре	Projective Capacitive Touch Panel
Activation	Two-fingers or Signal-finger
X/Y Position Reporting	Absolute Position
Touch Force	No contact pressure required
Calibration	No need for calibration
Report Rate	Approx 25 points/sec

Interface

CN6		
Pin No.	Symbol	Function
1	DGND	USB POWER GND
2	DA-	USB Data-
3	DA+	USB Data+
4	VDD	USB POWER 5V
5	NC	Non Use
6	NC	Non Use

* CN7 is for internal testing , please treat it No Connection.

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5. INTERFACE

Pin No.	Symbol	Function
1	VDD	POWER SUPPLY:3.3V
2	VDD	POWER SUPPLY:3.3V
3	GND	Power Ground
4	GND	Power Ground
5	IN0-	Transmission Data of Pixels
6	IN0+	Transmission Data of Pixels
7	GND	Power Ground
8	IN1-	Transmission Data of Pixels 1
9	IN1+	Transmission Data of Pixels 1
10	GND	Power Ground
11	IN2-	Transmission Data of Pixels 2
12	IN2+	Transmission Data of Pixels 2
13	GND	Power Ground
14	CLK-	Sampling Clock
15	CLK+	Sampling Clock
16	GND	Power Ground
17	VLED	POWER SUPPLY for Backlight, 12V
18	VLED	POWER SUPPLY for Backlight, 12V
19	GND	Power Ground
20	LEDADJ	LED PWM SIGNAL 3.3V

Note : ADJ PIN

Pin20: ADJ is PWM signal input. It is for brightness control.

ITEM	SYMBOL	MIN	TYP	MAX	UNIT
ADJ signal frequency	fPWM	5		100	KHz
ADJ signal logic level High	VIH	1.2V		VLED	V
ADJ signal logic level Low	VIL	0		0.4	V









ltem		Symbol	Condition	Min.	Тур.	Max.	Unit	Note
Viewing	Front	θf	CR≧10	65	75		deg.	(1)(2)(3)
	Back	θb		65	75			
Angle	Left	θI		65	75			
	Right	θr		65	75			
Contrast ratio		CR	Θ=Φ=0°		300			(1)(3)
Response Time		Tr	Q- \$ -0°		5	10	ms	(1)(4)
		T _f			11	16	ms	(1)(4)
Color chromaticity	W/bito	Wx	0-4-0	0.239	0.299	0.359		(1)
	VVIILE	Wy		0.268	0.328	0.388		
Luminance		L	Θ=Φ=0°	650	850		cd/m ²	(1)(5)
Luminance Uniformity		ΔL	Θ=Φ=0°	70			%	(1)(5)(6)

6. OPTICAL CHARACTERISTICS

Note 1: Ta=25°C. To be measured on the center area of panel after 10 minutes operation.

Note 2: Definition of Viewing Angle



Note 3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Photo detector output when LCD is at "White" state Contrast ratio (CR) = Photo detector Output when LCD is at "Black" state Note 4: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white"(falling time) and from "white" to "black" (rising time) respectively. The response time is defined as the time interval between the 10% and 90% of amplitudes. Refer to figure as below.







Note 6 : Definition of Luminance Uniformity

 $\Delta L = [L(min.) \text{ of } 9 \text{ points} / L(max.) \text{ of } 9 \text{ points}] X 100\%$



7. INPUT SIGNAL (DE ONLY MODE)

7-1 LVDS Singal

switching characteristics over recommended operating conditions (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP†	MAX	UNIT
t _{su}	Setup time, D0–D20 to CLKOUT↓		5			ns
th	Data hold time, CLKOUT↓ to D0–D20	CL = 8 pF, See Figure 5	5			ns
^t (RSKM)	Receiver input skew margin§ (see Figure 7)	t _c = 15.38 ns (±0.2%), Input clock jitter < 50 ps¶,	550	700		ps
t _d	Delay time, CLKIN1 to CLKOUT \downarrow (see Figure 7)	V _{CC} = 3.3 V, t _c = 15.38 ns (±0.2%), T _A = 25°C	3	5	7	ns
t _{en}	Enable time, SHTDN to phase lock	See Figure 7		1		ms
t _{dis}	Disable time, SHTDN to off state	See Figure 8		400		ns
tt	Transition time, output (10% to 90% $t_{f} \mbox{ or } t_{f})$ (data only)	CL = 8 pF		3		ns
tt	Transition time, output (10% to 90% $t_{\Gamma}\text{or}t_{f})$ (clock only)	CL = 8 pF		1.5		ns
tw	Pulse duration, output clock			0.50 t _C		ns

[†] All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

§ The parameter t_(RSKM) is the timing margin available to allocate to the transmitter and interconnection skews and clock jitter. The value of this parameter at clock periods other than 15.38 ns can be calculated from t_{RSKM} = tc/14 – 550 ps.

¶ Input clock jitter is the magnitude of the change in input clock period.

PARAMETER MEASUREMENT INFORMATION



Figure 5. Setup and Hold Time Waveforms







Figure 8. Disable Time Waveforms



7-2 TTL Signal (DE Only mode)

Daramatar	Symbol		Unit		
Parameter	Symbol	Min.	Тур.	Max.	Unit
Data setup time	Tdsu	6	-	-	ns
Data hold time	Tdhd	6	-	-	Tcph
DE setup time	Tesu	6	-	-	Tcph
CLK frequency	Есрн		33.26		MHz
CLK period	Тсрн		30.06		ns
CLK pulse duty	Тсwн	40	50	60	%
DE period	TDEH+TDEL	1000	1056	1200	Тсрн
DE pulse width	TDEH	-	800	-	Тсрн
DE frame blanking	TDEB	10	45	110	TDEH+TDEL
DE frame width	TDE	-	480	-	TDEH+TDEL

Note : We suggest using the typical value, so it can have better performance.









8. RELIABILITY TEST

Test Item	Test Conditions	Note
High Temperature Operation	70±3°C, t=240 hrs	
Low Temperature Operation	-20±3°C, t=240 hrs	
High Temperature Storage	80±3°C, t=240 hrs	1,2
Low Temperature Storage	-30±3°C, t=240 hrs	1,2
Storage at High Temperature and Humidity	60°C, 90% RH , 240 hrs	1,2
Thermal Shock Test	-20°C (30min) ~ 70°C (30min) 100 cycles	1,2
Vibration Test (Packing)	Sweep frequency : 10 ~ 55 ~ 10 Hz/1min Amplitude : 0.75mm Test direction : X.Y.Z/3 axis Duration : 30min/each axis	2

Note 1 : Condensation of water is not permitted on the module.

Note 2 : The module should be inspected after 1 hour storage in normal conditions (15-35°C , 45-65%RH).



10 USE PRECAUTIONS

10.1 Handling precautions

- (1) The polarizing plate may break easily so be careful when handling it. Do not touch, press or rub it with a hard-material tool like tweezers.
- (2) Do not touch the polarizing plate surface with bare hands so as not to make it dirty. If the surface or other related part of the polarizing plate is dirty, soak a soft cotton cloth or chamois leather in benzine and wipe off with it. Do not use chemical liquids such as acetone, toluene and isopropyl alcohol. Failure to do so may bring chemical reaction phenomena and deteriorations.
- (3) Remove any spit or water immediately. If it is left for hours, the suffered part may deform or decolorize.
- (4) If the LCD element breaks and any LC stuff leaks, do not suck or lick it. Also if LC stuff is stuck on your skin or clothing, wash thoroughly with soap and water immediately.

10.2 Installing precautions

- (1) The PCB has many ICs that may be damaged easily by static electricity. To prevent breaking by static electricity from the human body and clothing, earth the human body properly using the high resistance and discharge static electricity during the operation. In this case, however, the resistance value should be approx. $1M\Omega$ and the resistance should be placed near the human body rather than the ground surface. When the indoor space is dry, static electricity may occur easily so be careful. We recommend the indoor space should be kept with humidity of 60% or more. When a soldering iron or other similar tool is used for assembly, be sure to earth it.
- (2) When installing the module and ICs, do not bend or twist them. Failure to do so may crack LC element and cause circuit failure.
- (3) To protect LC element, especially polarizing plate, use a transparent protective plate (e.g., acrylic plate, glass etc) for the product case.
- (4) Do not use an adhesive like a both-side adhesive tape to make LCD surface (polarizing plate) and product case stick together. Failure to do so may cause the polarizing plate to peel off

10.3 Storage precautions

- (1) Avoid a high temperature and humidity area. Keep the temperature between 0°C and 35°C and also the humidity under 60%.
- (2) Choose the dark spaces where the product is not exposed to direct sunlight or fluorescent light.
- (3) Store the products as they are put in the boxes provided from us or in the same conditions as we recommend.



10.4 Operating precautions

- (1) Do not boost the applied drive voltage abnormally. Failure to do so may break ICs. When applying power voltage, check the electrical features beforehand and be careful. Always turn off the power to the LC module controller before removing or inserting the LC module input connector. If the input connector is removed or inserted while the power is turned on, the LC module internal circuit may break.
- (2) The display response may be late if the operating temperature is under the normal standard, and the display may be out of order if it is above the normal standard. But this is not a failure; this will be restored if it is within the normal standard.
- (3) The LCD contrast varies depending on the visual angle, ambient temperature, power voltage etc. Obtain the optimum contrast by adjusting the LC dive voltage.
- (4) When carrying out the test, do not take the module out of the low-temperature space suddenly. Failure to do so will cause the module condensing, leading to malfunctions.
- (5) Make certain that each signal noise level is within the standard (L level: 0.2Vdd or less and H level: 0.8Vdd or more) even if the module has functioned properly. If it is beyond the standard, the module may often malfunction. In addition, always connect the module when making noise level measurements.
- (6) The CMOS ICs are incorporated in the module and the pull-up and pull-down function is not adopted for the input so avoid putting the input signal open while the power is ON.
- (7) The characteristic of the semiconductor element changes when it is exposed to light emissions, therefore ICs on the LCD may malfunction if they receive light emissions. To prevent these malfunctions, design and assemble ICs so that they are shielded from light emissions.
- (8) Crosstalk occurs because of characteristics of the LCD. In general, crosstalk occurs when the regularized display is maintained. Also, crosstalk is affected by the LC drive voltage. Design the contents of the display, considering crosstalk.

10.5 Other

- (1) Do not disassemble or take the LC module into pieces. The LC modules once disassembled or taken into pieces are not the guarantee articles.
- (2) The residual image may exist if the same display pattern is shown for hours. This residual image, however, disappears when another display pattern is shown or the drive is interrupted and left for a while. But this is not a problem on reliability.
- (3) USMP will provide one year warrantee for all products and three months warrantee for all repairing products..

11 OUTLINE DIMENSION



